SCAS004 - D2957, JULY 1987 - REVISED APRIL 1993

- 8-Latches in a Single Package
- 3-State Bus-Driving Inverting Outputs
- Full Parallel Access for Loading
- Buffered Control Inputs
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

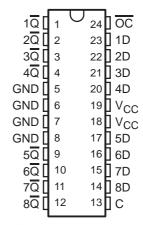
description

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

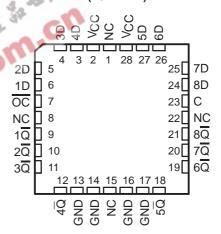
The eight latches of the 'AC11533 are transparent D-type latches. While the enable (C) is high, the \overline{Q} outputs will follow the complements of the (D) inputs. When the output control \overline{OC} is taken low, the \overline{Q} outputs will be latched. The 'AC11533 is functionally equivalent to the 'AC11373 except for having inverted outputs.

A buffered output-control (\overline{OC}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state,

54AC11533 . . . JT PACKAGE 74AC11533 . . . DW OR NT PACKAGE (TOP VIEW)



54AC11533 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

the outputs neither load nor drive the bus lines significantly. The high-impedance third state and increased drive provide the capability to drive the bus lines in a bus-organized system without need for interface or pull-up components.

The output control (\overline{OC}) does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are off.

The 54AC11533 is characterized for operation over the full military temperature range of -55° C to 125° C. The 74AC11533 is characterized for operation from -40° C to 85° C.

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FUNCTION TABLE (each latch)

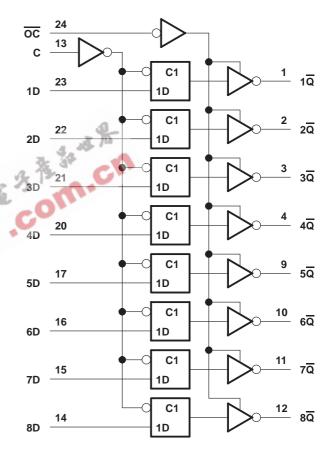
	OUTPUT		
oc	С	D	Q
L	Н	Н	L
L	Н	L	Н
L	L	Χ	\overline{Q}_0
Н	X	X	Z

logic symbol†

<u>oc</u> ΕN 13 С C1 23 1D 1Q 1D 2 22 2D 2Q 3 21 3D 3Q 4 20 4Q 4D 17 9 5Q 5D 16 10 6Q 6D 15 11 7Q 7D 14 12 8<u>Q</u> 8D

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	0.5 V to 6 V
Input voltage range, V _I (see Note 1)	–0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±200 mA
Storage temperature range	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.



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recommended operating conditions

			54	54AC11533		74AC11533			
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vсс	Supply voltage		3	5	5.5	3	5	5.5	V
		V _{CC} = 3 V	2.1			2.1			
VIH	High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
		V _{CC} = 5.5 V	3.85			3.85			
		V _{CC} = 3 V			0.9			0.9	
VIL	Low-level input voltage	V _{CC} = 4.5 V			1.35			1.35	V
		V _{CC} = 5.5 V			1.65			1.65	
VI	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
		V _{CC} = 3 V			- 4			- 4	
ЮН	High-level output current	V _{CC} = 4.5 V			- 24			- 24	mA
		V _{CC} = 5.5 V			-24			-24	
		V _{CC} = 3 V		-43	12			12	
lOL	Low-level output current	V _{CC} = 4.5 V		五万	24			24	mA
		V _{CC} = 5.5 V	1 34 A		24			24	
$\Delta t/\Delta v$	Input transition rise or fall rate	- Sc	0	C	10	0		10	ns/V
TA	Operating free-air temperature		-55	100	125	- 40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	V	T,	<u> </u> = 25°C	;	54AC1	1533	74AC1	1533	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
		3 V	2.9			2.9		2.9		
	$I_{OH} = -50 \mu A$	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
V _{OH}	I _{OH} = - 4 mA	3 V	2.58			2.4		2.48		٧
VOH	I _{OH} = - 24 mA	4.5 V	3.94			3.7		3.8		V
		5.5 V	4.94			4.7		4.8		
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	I _{OL} = 50 μA	3 V			0.1		0.1		0.1	
		4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
V _{OL}	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	V
VOL.	I _{OL} = 24 mA	4.5 V			0.36		0.5		0.44	v
		5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	I _{OL} = 75 mA [†]	5.5 V							1.65	
loz	$V_O = V_{CC}$ or GND	5.5 V			± 0.5		± 10		± 5	μΑ
lį	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1		± 1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		160		80	μΑ
Ci	V _I = V _{CC} or GND	5 V		4						pF
Co	$V_O = V_{CC}$ or GND	5 V		10						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



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timing requirements (see Figure 1)

		Vcс	T _A = 25°C		54AC11533		74AC11533		
		RANGE	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
		$3.3\pm0.3~\textrm{V}$	5.5		5.5		5.5		
t _W	Pulse duration, C high	5 ± 0.5 V	4		4		4		ns
	Oaton the add to be form O	$3.3\pm0.3~\text{V}$	4		4		4		
tsu	Setup time, data before C	5 ± 0.5 V	3.5		3.5		3.5		ns
	Held Core data affect Of	$3.3\pm0.3~\textrm{V}$	2		2		2		
th	Hold time, data after C↓	5 ± 0.5 V	2		2		2		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	T,	λ = 25°C	;	54AC1	11533	74AC1	1533				
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT			
t _{PLH}	D	Īα	1.5	8.5	12.6	1.5	15.2	1.5	14.3				
^t PHL	U	Q	1.5	7.5	10.1	1.5	12	1.5	11.3	ns			
tPLH	^	A	1.5	10	14.5	1.5	17.6	1.5	16.5				
^t PHL	С	Any Q	Ally Q	1.5	9.5	12.8	1.5	15.2	1.5	14.3	ns		
^t PZH	<u>oc</u>	A	1.5	9	13.1	1.5	15.7	1.5	14.7				
t _{PZL}	00	Any Q	Any Q	Ally Q	Ally Q	1.5	8.5	11.6	1.5	14.1	1.5	13.1	ns
^t PHZ	oc	Any Q	1.5	9.5	12	1.5	13.2	1.5	12.8	20			
tPLZ	00	Any Q	1.5	7.5	10.2	1.5	11.4	1.5	11	ns			

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

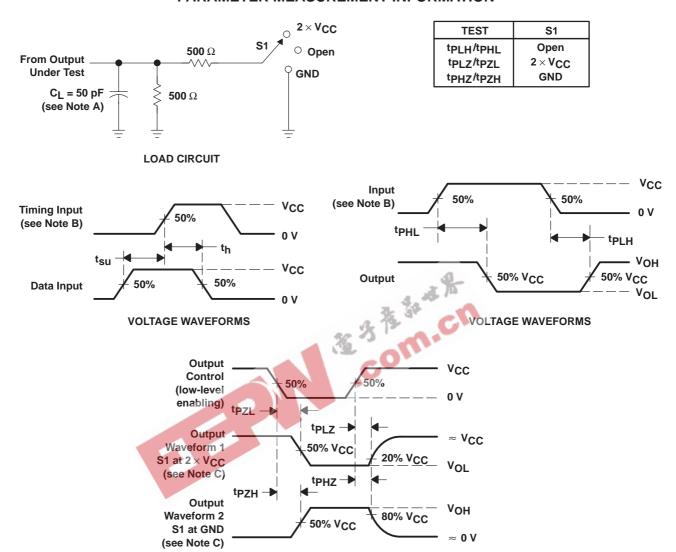
	FROM			T _A = 25°C		54AC11533		74AC11533		LINUT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t _{PLH}	D	ū	1.5	5.5	8.4	1.5	10.6	1.5	9.8	
^t PHL	D	Q	1.5	5	7.1	1.5	8.6	1.5	8	ns
t _{PLH}	0	A -	1.5	6.5	10	1.5	12.1	1.5	11.3	
^t PHL	С	Any Q	1.5	6.5	9.1	1.5	11	1.5	10.3	ns
^t PZH	oc	A -	1.5	6.5	9.5	1.5	11.7	1.5	10.8	
tPZL	OC	Any Q	1.5	6	8.6	1.5	10.9	1.5	9.7	ns
^t PHZ	oc	A 🔽	1.5	8.5	10.7	1.5	11.7	1.5	11.4	
^t PLZ	OC	Any Q	1.5	6	8.2	1.5	9.3	1.5	8.9	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER			TEST CONDITIONS	TYP	UNIT
	Davis discination consistence nonletch	Outputs enabled	0 50 -5 4 4 MH-	55	
Cpd	Power dissipation capacitance per latch	Outputs disabled	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	44	pF

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

VOLTAGE WAVEFORMS

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

24-Jun-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC11533DW	OBSOLETE	SOIC	DW	24	TBD	Call TI	Call TI
74AC11533NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI
74AC11533NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI
74AC11533NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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